## TSSPB-2325G-LR & TSSPB-3225G-LR Series

Tx: 1270nm/Rx: 1330nm BIDI SFP+ 10km Transceiver for 25GbE Tx: 1330nm/Rx: 1270nm BIDI SFP+ 10km Transceiver for 25GbE

### **Features**

- Compliant with MSA SFP+ Specification SFF-8402
- · Compliant with SFP+ MSA with LC connector
- 2-wire interface with integrated Digital Diagnostic monitoring
- Data Rate up to 25.78 Gb/s
- 1270nm DFB laser and PIN receiver for TSSPB-2325G-LR
  1330nm DFB laser and PIN receiver for TSSPB-3225G-LR
- Metal enclosure, for lower EMI
- Distance up to 10km transmission on SMF
- Single 3.3V Power Supply and Power Dissipation < 1.2W
- Case operation temperature range: Standard temperature: 0°C to 70°C
   Extended temperature: -40°C to 85°C
- RoHS6 compliant (lead free)



- 25G Ethernet
- CPRI 10

### Description

T&S 25G BIDI SFP28 transceivers are designed for bi-directional 25G serial optical data communications by using 1270nm/1330nm or 1270nm/1310nm wavelengths. The modules are suitable for 25G Ethernet and CPRI (option 10) applications, like in 5G mobile networks. The family offers modules for the I-temp range from -40 °C to +85°C and C-temp range from 0°C to +70°C.

### **Absolute Maximum Ratings**

Parameters	Symbol	Min.	Max.	Unit
Power Supply Voltage	VCC	-0.5	+3.6	V
Storage Temperature	Тс	-40	+85	°C
Relative Humidity	RH	0	85	%



## **Recommended Operating Conditions**

Parameter	Symbol	Min	Typical	Max	Unit
Power Supply Voltage	VCC	3.15	3.30	3.45	V
Operating Case Temperature(standard)	Tca	0	-	70	°C
Operating Case Temperature(industrial)	Тса	-40	-	85	°C

## **Electrical Characteristics**

Parameter	Symbol	Min.	Typical	Max	Unit
Supply Current	Icc	-	-	348	mA
Power Consumption	-	-	-	1200	mW
Transmitter					
Input differential impedance <sup>1</sup>	Rin	-	100	-	Ω
Differential Input Voltage swing	Vin	300	-	1100	mV
Transmit Disable Voltage	VD	VCC -1.3	-	VCC	V
Transmit Enable Voltage <sup>2</sup>	Ven	Vee	-	Vee+0.8	V
Receiver					
Output differential impedance	Rout	-	100	-	Ω
Differential Output Swing <sup>3</sup>	Vout	500	-	800	mV
Loss of Signal –Asserted <sup>4</sup>	-	2.0	-	VCC+0.3	V
Loss of Signal –Negated4	-	Vee	-	Vee+0.8	V

### Notes:

[1] Connected directly to TX data input pins. AC coupled thereafter.

## Optical Characteristics (TSSPB-2325G-LR, 1270 DFB & PIN/TIA)

Parameter	Symbol	Min.	Typical	Max	Unit
Transmitter					
Optical Wavelength	λ	1260	1270	1280	nm
Side Mode Suppress Ratio	SMSR	30	-	-	dB
Spectral Width (-20dB)	Δλ	-	-	1	nm
Average Output Power	Ро	-5	-	2	dBm
Extinction Ratio	ER	3.5	-	-	dB
Receiver		1	1	1	

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<sup>[2]</sup> Or open circuit.

<sup>[3]</sup> Into 100 ohms differential termination.

<sup>[4]</sup> Loss Of Signal is LVTTL. Logic 0 indicates normal operation; logic 1 indicates no signal detected.

Receiver Sensitivity (OMA)	SEN	-	-	-18	dBm
Receiver Overload	Pmax	2	-	-	dBm
Centre Wavelength	λ	1320	-	1340	nm
LOS De-Assert	Lda	-	-	-19	dBm
LOS Assert	Lsa	-30	-	-	dBm
LOS Hysteresis	Lh	0.5	-	-	dB

# Optical Characteristics (TSSPB-3225G-LR, 1330 DFB & PIN/TIA)

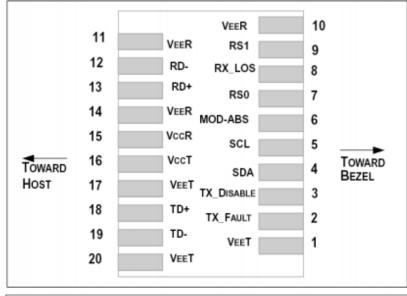
Parameter	Symbol	Min.	Typical	Мах	Unit		
Transmitter							
Optical Wavelength	λ	1320	1330	1340	nm		
Side Mode Suppress Ratio	SMSR	30	-	-	dB		
Spectral Width(-20dB)	Δλ	-	-	1	nm		
Average Output Power <sup>1 &amp; 2</sup>	Ро	-5	-	2	dBm		
Extinction Ratio	ER	3.5	-	-	dB		
Receiver							
Receiver Sensitivity (OMA) <sup>2</sup>	SEN	-	-	-18	dBm		
Receiver Overload	Pmax	2	-	-	dBm		
Centre Wavelength	λ	1260	-	1270	nm		
LOS De-Assert	Lda	-	-	-19	dBm		
LOS Assert	Lsa	-30	-	-	dBm		
LOS Hysteresis	Lh	0.5	-	-	dB		

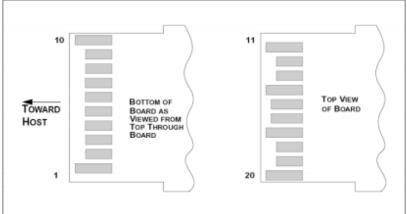
### Notes:

<sup>[1]</sup> Class 1 Laser Safety per FDA/CDRH and IEC-825-1 regulations.

<sup>[2]</sup> Measured with a PRBS  $2^{31}$ -1 test pattern, @25.78Gb/s, BER@5x10-5

## **Electrical Pad Layout**





## **Pin Definition**

Pin	Symbol	Name/Description
1	VEET [1]	Transmitter Ground
2	Tx_FAULT [2]	Transmitter Fault
3	Tx_DIS[3]	Transmitter Disable. Laser output disabled on high or open
4	SDA [2]	2-wire Serial Interface Data Line
5	SCL [2]	2-wire Serial Interface Clock Line
6	MOD_ABS [4]	Module Absent. Grounded within the module
7	RS0 [5]	No connection required
8	RX_LOS [2]	Loss of Signal indication. Logic 0 indicates normal operation
9	RS1 [5]	No connection required

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10	VEER[1]	Receiver Ground
11	VEER [1]	Receiver Ground
12	RD-	Receiver Inverted DATA out. AC Coupled
13	RD+	Receiver DATA out. AC Coupled
14	VEER [1]	Receiver Ground
15	VCCR	Receiver Power Supply
16	VCCT	Transmitter Power Supply
17	VEET [1]	Transmitter Ground
18	TD+	Transmitter DATA in. AC Coupled
19	TD-	Transmitter Inverted DATA in. AC Coupled
20	VEET [1]	Transmitter Ground

#### Notes:

- [1] Module circuit ground is isolated from module chassis ground within the module.
- [2] Should be pulled up with 4.7k 10k ohms on host board to a voltage between 3.15V and 3.6V.
- [3] Tx\_Disable is an input contact with a 4.7 k $\Omega$  to 10 k $\Omega$  pullup to VCCT inside the module.
- [4] Mod\_ABS is connected to VeeT or VeeR in the SFP+ module. The host may pull this contact up to VCC\_Host with a resistor in the range  $4.7 \text{ k}\Omega$  to  $10 \text{ k}\Omega$ . Mod\_ABS is asserted "High" when the SFP+ module is physically absent from a host slot.
- [5] RS0 and RS1 are module inputs and are pulled low to VeeT with > 30 k $\Omega$  resistors in the module.

## **Ordering Information**

Part Number	Product Description	
TSSPB-2325G-LRC	25Gbps, SFP+ BIDI TX1270nm/RX1330nm 10km,	0°C ~ +70°C
TSSPB-3225G-LRC	25Gbps, SFP+ BIDI TX1330nm/RX1270nm, 10km,	0°C ~ +70°C
TSSPB-2325G-LRT	25Gbps, SFP+ BIDI TX1270nm/RX1330nm 10km,	-40°C ~ +85°C
TSSPB-3225G-LRT	25Gbps, SFP+ BIDI TX1330nm/RX1270nm, 10km,	-40°C ~ +85°C

### References

- 1. SFP28 MSA
- 2. Directive 2011/65/EU of the European Parliament and of the Council, "on the restriction of the use of certain hazardous substances in electrical and electronic equipment," July 1, 2011.

### **Important Notice**

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